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Infineon Technologies BFR 193 E6327

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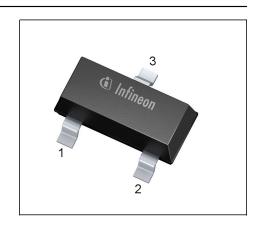




BFR193

Low Noise Silicon Bipolar RF Transistor

- For low noise, high-gain amplifiers up to 2 GHz
- For linear broadband amplifiers
- f_T = 8 GHz, NF_{min} = 1 dB at 900 MHz
- Pb-free (RoHS compliant) package
- Qualification report according to AEC-Q101 available





ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pin Configuration			Package
BFR193	RCs	1 = B	2 = E	3 = C	SOT23

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{\sf CEO}$	12	V
Collector-emitter voltage	V_{CES}	20	
Collector-base voltage	V_{CBO}	20	
Emitter-base voltage	V_{EBO}	2	
Collector current	I _C	80	mA
Base current	l _B	10	
Total power dissipation ¹⁾	P _{tot}	580	mW
<i>T</i> _S ≤ 69°C			
Junction temperature	TJ	150	°C
Storage temperature	T_{Stq}	-55 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ²⁾	R_{thJS}	140	K/W

 $^{{}^{1}}T_{\rm S}$ is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{th,IS} please refer to Application Note AN077 (Thermal Resistance Calculation)



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Datasheet of BFR 193 E6327 - TRANSISTOR NPN RF 12V SOT-23

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Electrical Characteristics at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	mbol		Values	
		min.	typ.	max.	
DC Characteristics			•		•
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C}$ = 1 mA, $I_{\rm B}$ = 0					
Collector-emitter cutoff current	I _{CES}	-	-	100	μΑ
$V_{CE} = 20 \text{ V}, V_{BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μΑ
$V_{\rm EB} = 1 \text{ V}, I_{\rm C} = 0$					
DC current gain	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					





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Parameter	Symbol		Values		Unit
		min.	typ.	max.	
AC Characteristics (verified by random sampling	ng)		ı		1
Transition frequency	f_{T}	6	8	-	GHz
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz					
Collector-base capacitance	C _{cb}	-	0.66	1	pF
$V_{\text{CB}} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\text{BE}} = 0$,					
emitter grounded					
Collector emitter capacitance	C _{ce}	-	0.28	-	
$V_{\text{CE}} = 10 \text{ V}, f = 1 \text{ MHz}, V_{\text{BE}} = 0$,					
base grounded					
Emitter-base capacitance	C _{eb}	-	2.25	-	
$V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$,					
collector grounded					
Minimum noise figure	NF _{min}				dB
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,					
f = 900 MHz		-	1	-	
f = 1.8		-	1.6	-	
Power gain, maximum available ¹⁾	G _{ma}				1
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$, $Z_{\rm L}$ = $Z_{\rm Lopt}$,					
f = 900 MHz		-	15	_	
f = 1.8 GHz		-	10	_	
Transducer gain	$ S_{21e} ^2$				dB
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 900 MHz		_	13	_	
f = 1.8 GHz		_	7.5	_	
Third order intercept point at output ²⁾	IP ₃	-	30	_	dBm
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 0.9 GHz					
1dB Compression point	P _{-1dB}	-	13	_	1
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,					
f = 0.9 GHz					

 $^{{}^{1}}G_{\text{ma}} = |S_{21} / S_{12}| (k - (k^{2} - 1)^{1/2})$

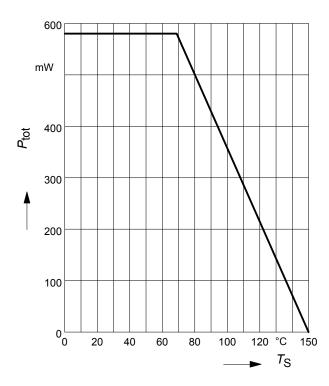
²IP3 value depends on termination of all intermodulation frequency components.

Termination used for this measurement is 50Ω from 0.2 MHz to 12 GHz



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Total power dissipation $P_{\text{tot}} = f(T_{\text{S}})$





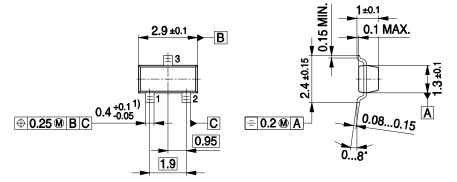


Package SOT23

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Package Outline

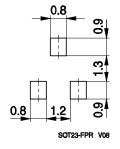




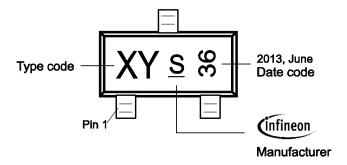
1) Lead width can be 0.6 max. in dambar area

SOT23-PO V08

Foot Print



Marking Layout (Example)



Standard Packing

Reel Ø 180 mm = 3.000 Pieces/ Reel

Reel Ø 330 mm = 10.000 Pieces/ Reel

Pin 1

3.15

SOT23-TP, V02



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BFR193

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